

Description

The SI7139DP-T1-GE3 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

V_{DS} = -30VI _D =-70A

 $R_{DS(ON)} < 8.8 m_{\Omega} V_{GS}$ =-10V

Application

Battery protection

Load switch

Uninterruptible power supply

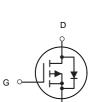
Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
SI7139DP-T1-GE3	DFN5X6-8L	HXY MOSFET	5000

Absolute Maximum Ratings (Tc=25 °C unless otherwise noted)

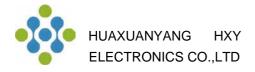
Symbol	Parameter	Rating	Units	
Vds	Drain-Source Voltage	-30	V	
VGS	Gate-Source Voltage	±20	V	
l₀@Tc=25°C	Continuous Drain Current, V _{GS} @ 10V ¹	-70	Α	
l⊳@Tc=75°C	Continuous Drain Current, V _{GS} @ 10V ¹	-40	А	
Ірм	Pulsed Drain Current ²	-175	А	
EAS	Single Pulse Avalanche Energy ³	31	mJ	
P₀@Tc=25°C	Total Power Dissipation ⁴	31.2	W	
Тѕтд	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	
Rejc	Thermal Resistance Junction-Case ¹	4	°C/W	
Reja	Thermal Resistance Junction-Ambient ¹	61	°C/W	





DFN5X6-8L

P-Channel MOSFET



SI7139DP-T1-GE3

P-Channel Enhancement Mode MOSFET

ElectricalCharacteristics(TJ=25℃ unless otherwise noted)

Parameter		Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Drain-Source Breakdown Voltage		V _{(BR)DSS}	V _{GS} = 0V, I _D = -250µA	-30	-	-	V	
Gate-body Leakage current		lgss	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA	
Zero Gate Voltage Drain Current	TJ=25℃	- I _{DSS}	$V_{DS} = -24V, V_{GS} = 0V$	-	-	-1	μA	
	TJ=55℃	IDSS	$v_{\rm DS} = -24v, v_{\rm GS} = 0v$	-	-	-5		
Gate-Threshold Voltage		V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1.0	-1.6	-2.5	V	
Drain-Source On-Resistance ²		P	V _{GS} = -10V, I _D = -12A	-	6	8.8		
		R _{DS(on)}	V _{GS} = -4.5V, I _D = -8A	-	9	14	mΩ	
Forward Transconductance		g fs	V _{DS} = -5V, I _D = -20A	-	28	-	S	
Input Capacitance		Ciss		-	4320	-	pF	
Output Capacitance		Coss	V _{DS} = -15V, V _{GS} =0V, f =1MHz	-	529	-		
Reverse Transfer Capacitance		Crss		-	487	-		
Gate Resistance		Rg	V_{DS} = 0V, V_{GS} = 0V, f=1.0MHz	-	4.0	-	Ω	
Total Gate Charge		Qg		-	45	-		
Gate-Source Charge		Q _{gs}	V _{GS} = -10V, V _{DS} = -15V, I _D = -15A	-	8.5	-	nC	
Gate-Drain Charge	Gate-Drain Charge			-	12.8	-		
Turn-On Delay Time		td(on)		-	18.9	-	nS	
Rise Time		tr	V_{GS} = -10V, V_{DD} = -15V, R _G = 2.5Ω, I _D = -15A	-	15.7	-		
Turn-Off Delay Time		t _{d(off)}		-	64.8	-		
Fall Time		tr		-	36.5	-		
Diode Forward Voltage ²		Vsd	I _S = -1A, V _{GS} = 0V	-	-	-1	V	
Continuous Source Current ^{1,5}		Is	Vg=VD=0V , Force Current	-	-	-70	Α	

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.

2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

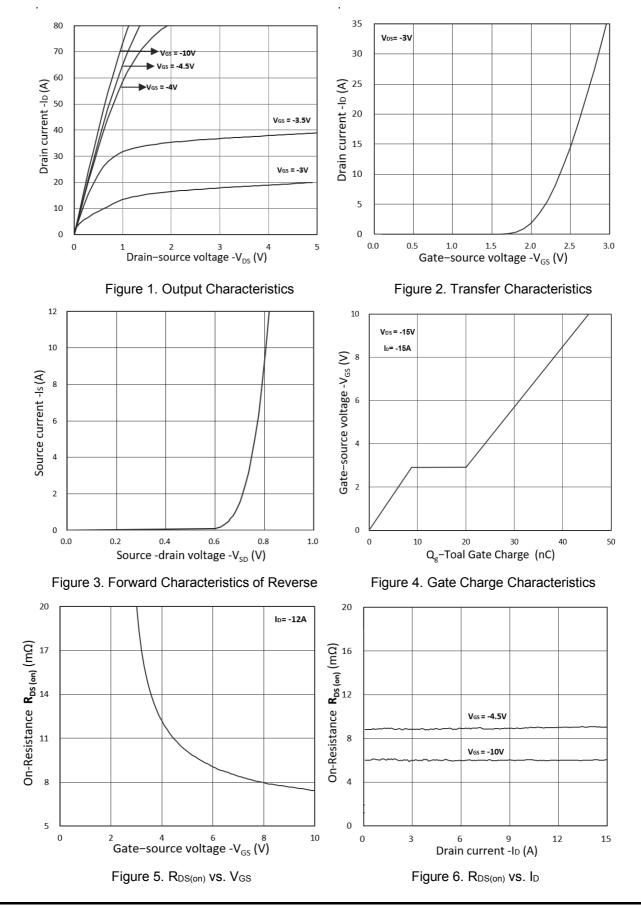
3. The EAS data shows Max. rating . The test condition is V_DD= -25V, V_GS= -10V, L= 0.1mH, I_{AS}= -25A

4.The power dissipation is limited by 150°C junction temperature

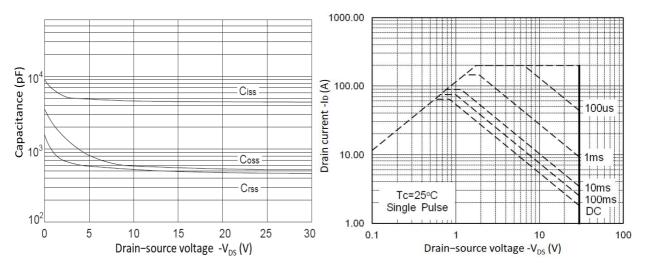
5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

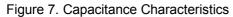


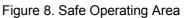
Typical Electrical And Thermal Characteristics (Curves)

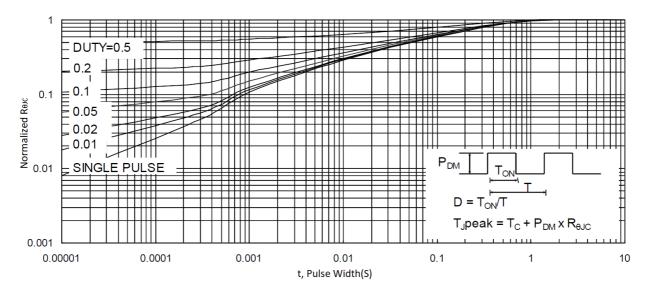


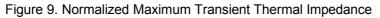












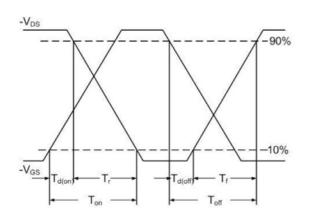
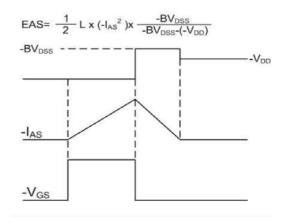
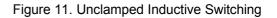


Figure 10. Switching Time Waveform

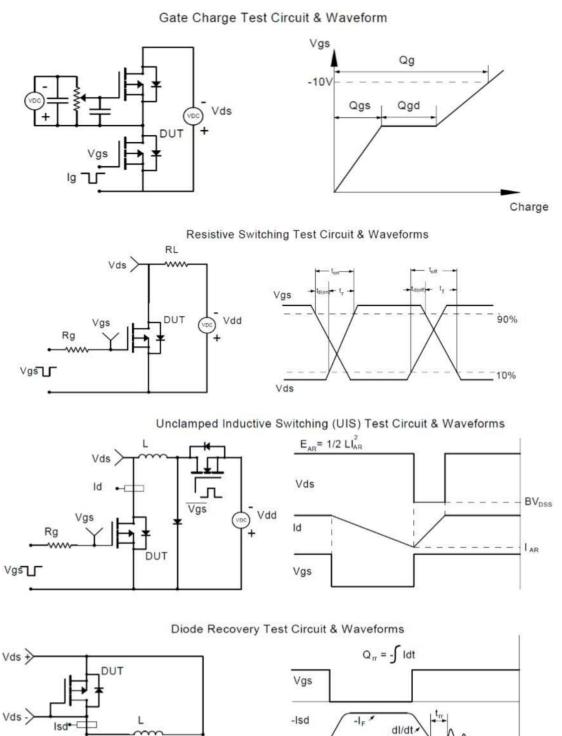




Waveform



Test Circuit



Vdd

-Vds

Vgs

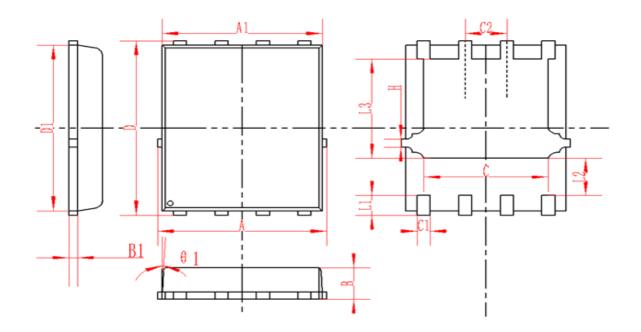
lg _

Vdd

-LRM



DFN5X6-8L Package Information



SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
А	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
В	0.9	0.95	1	0.035	0.037	0.039
B1	0.254REF		0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2		1.27TYP			0.5TYP	
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Н	0.24	0.25	0.26	0.009	0.010	0.010



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